

200mW, 4 PIN DIP Phototransistor Photocoupler

FEATURES

- Current transfer ratio
(CTR: MIN.80% at $I_F=5mA$, $V_{CE}=5V$)
- High isolation voltage between input and output
($V_{iso}=5000V$ rms)
- Creepage distance $> 7.62mm$
- UL Recognized File # E478892
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

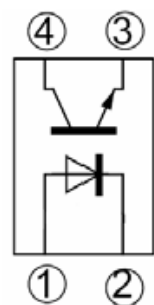
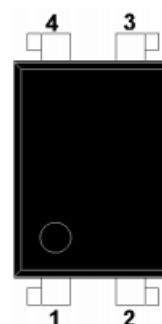
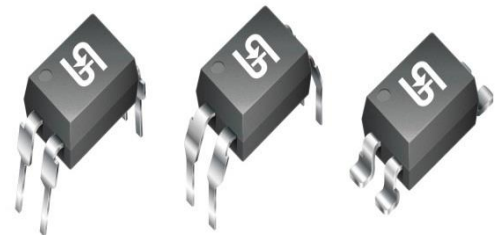
APPLICATIONS

- Programmable controllers
- System appliances, measuring instruments
- Telecommunication equipments
- Home appliances, such as fan heaters, etc
- Signal transmission between circuits of different potentials and impedances

MECHANICAL DATA

- Case: DIP-4 , DIP-4M , SOP-4
- Molding compound: UL flammability classification rating 94V-0
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: Indicated by cathode band

| KEY PARAMETERS | | |
|----------------|--------------------------|------|
| PARAMETER | VALUE | UNIT |
| CTR | 80-600 | % |
| V_{CEO} | 80 | V |
| P_{tot} | 200 | mW |
| I_C | 50 | mA |
| V_{iso} | 5000 | Vrms |
| Package | DIP-4 DIP-4M SOP-4 | |
| Configuration | Single Dice | |



| ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted) | | | | |
|--|-----------------------------|---------------|--------------------|------------------|
| PARAMETER | | SYMBOL | PART NUMBER | UNIT |
| Input | Forward current | I_F | 50 | mA |
| | Reverse voltage | V_R | 6 | V |
| | Power dissipation | P | 70 | mW |
| Output | Collector-emitter voltage | V_{CEO} | 80 | V |
| | Emitter-collector voltage | V_{ECO} | 6 | V |
| | Collector current | I_C | 50 | mA |
| | Collector power dissipation | P_C | 150 | mW |
| Total power dissipation | | P_{tot} | 200 | mW |
| Isolation voltage | | V_{iso} | 5000 | Vrms |
| Rated impulse isolation voltage | | V_{IOTM} | 6000 | V |
| Rated repetitive peak isolation voltage | | V_{IORM} | 630 | V |
| Operating temperature | | T_{opr} | -40 to +100 | $^\circ\text{C}$ |
| Storage temperature | | T_{stg} | -55 to +125 | $^\circ\text{C}$ |
| Soldering temperature | | T_{sol} | 260 | $^\circ\text{C}$ |

| ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted) | | | | | | | |
|---|--------------------------------------|--|---|--------------------|------------|------------|---------------|
| PARAMETER | | CONDITIONS | SYMBOL | MIN | TYP | MAX | UNIT |
| Input | Forward voltage | $I_F=20\text{mA}$ | V_F | | 1.2 | 1.4 | V |
| | Reverse current | $V_R=4\text{V}$ | I_R | | | 10 | μA |
| | Terminal capacitance | $V=0, f=1\text{kHz}$ | C_t | | 30 | 250 | pF |
| Output | Collector dark current | $V_{CE}=20\text{V}, I_F=0$ | I_{CEO} | | | 10^{-7} | A |
| | Collector-emitter breakdown voltage | $I_C=0.1\text{mA}, I_F=0$ | BV_{CEO} | 80 | | | V |
| | Emitter-collector breakdown voltage | $I_E=10\mu\text{A}, I_F=0$ | BV_{ECO} | 6 | | | V |
| Transfer Characteristics | Collector current | | I_C | 2.5 | | 30 | mA |
| | Current transfer ration(Note 1) | $I_F=5\text{mA}, V_{CE}=5\text{V}$ | CTR | 80 | | 600 | % |
| | Collector-emitter saturation voltage | $I_F=20\text{mA}, I_C=1\text{mA}$ | $V_{CE(sat)}$ | | 0.1 | 0.2 | V |
| | Isolation resistance | DC500V, 40 to 60%RH | R_{ISO} | 5×10^{10} | 10^{11} | | Ω |
| | Floating capacitance | $V=0, f=1\text{MHz}$ | C_f | | 0.6 | 1.0 | pF |
| | Cut-off frequency | $V_{CE}=5\text{V}, I_C=2\text{mA}, R_L=100\Omega, -3\text{dB}$ | f_c | | 80 | | KHz |
| | Response time | Rise time | $V_{CE}=2\text{V}, I_C=2\text{mA}, R_L=100\Omega$ | t_r | | 4 | 18 |
| Fall time | | | t_f | | 3 | 18 | μs |

Notes:

1. Classification table of current transfer ratio is shown below

RANK TABLE OF CURRENT TRANSFER RATIO, CTR

| RANK MARK | MIN (%) | MAX (%) |
|-----------|---------|---------|
| A | 80 | 160 |
| B | 130 | 260 |
| C | 200 | 400 |
| D | 300 | 600 |

| ORDERING INFORMATION | | | | |
|------------------------|--------------|---------------------|-------------------------------------|---------------|
| PART NO. (Note 1&2) | PACKING CODE | PACKING CODE SUFFIX | PACKAGE | PACKING |
| TPC817x | C9 | G | DIP-4 | 100 / TUBE |
| TPC817Mx | C9 | | DIP-4M (Leads with 0.4" spacing) | 100 / TUBE |
| TPC817S1x | RA | | SOP-4 | 2K / 13" Reel |

Notes:

1. "x" defines CTR rank from "A" to "D"
2. Whole series with green compound

| EXAMPLE | | | | |
|-------------|----------|--------------|---------------------|----------------|
| EXAMPLE P/N | PART NO. | PACKING CODE | PACKING CODE SUFFIX | DESCRIPTION |
| TPC817A C9G | TPC817A | C9 | G | Green compound |

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig. 1 Forward Current vs. Ambient Temperature

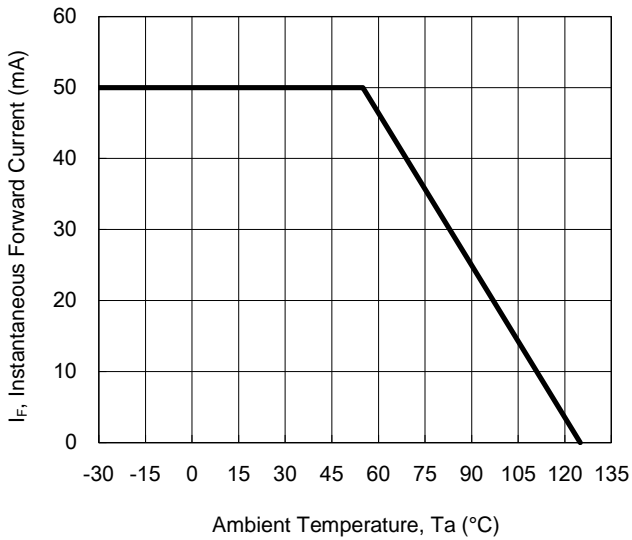


Fig.2 Collector Power Dissipation vs. Ambient Temperature

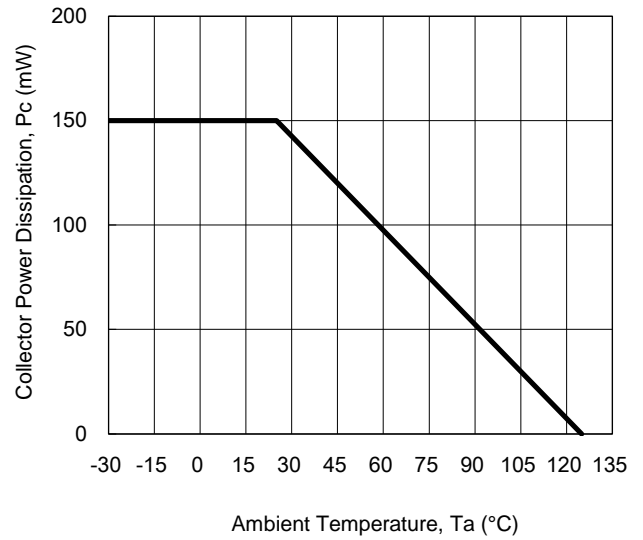


Fig.3 Collector-Emitter Saturation Voltage vs Forward Current

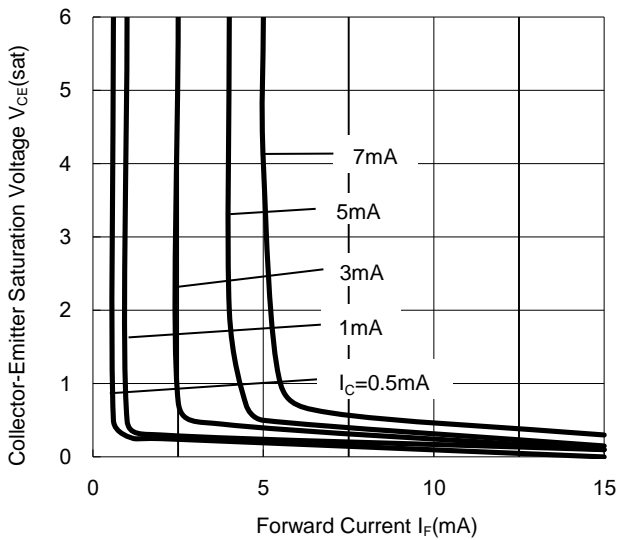


Fig.4 Forward Current vs. Forward Voltage



CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig. 5 Current Transfer Ratio vs. Forward Current

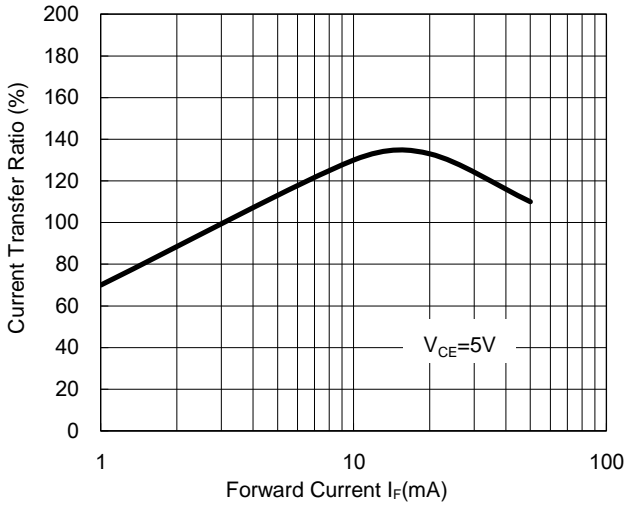


Fig. 6 Collector Current vs. Collector-Emitter Voltage

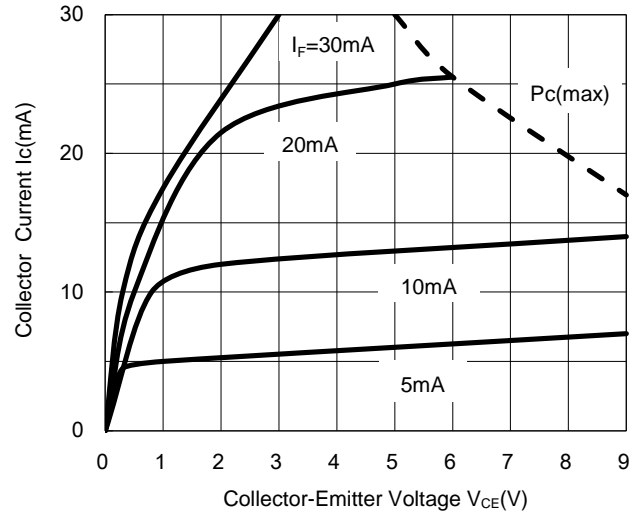
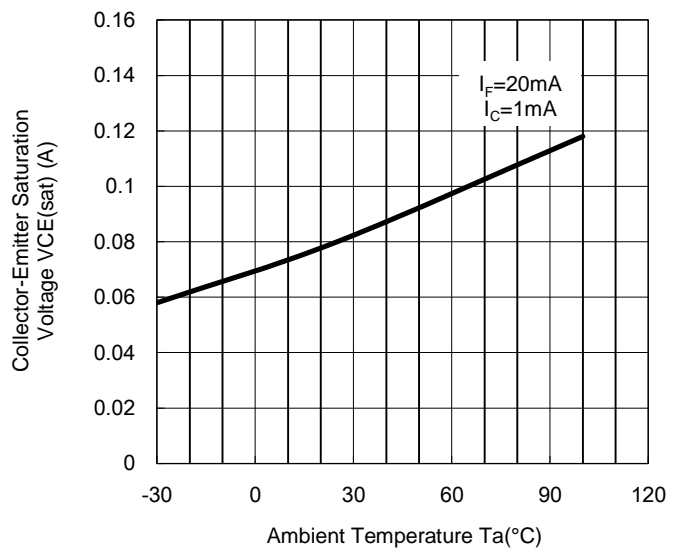


Fig. 7 Relative Current Transfer Ratio vs. Ambient Temperature



Fig. 8 Collector-emitter Saturation Voltage vs. Ambient Temperature



CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig. 9 Collector Dark Current vs. Ambient Temperature

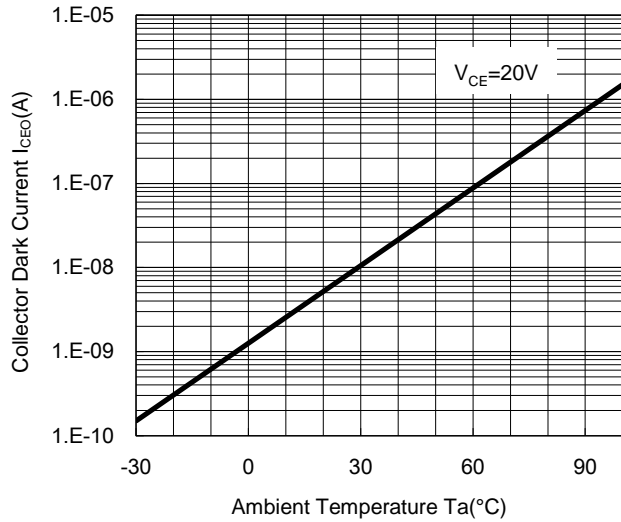
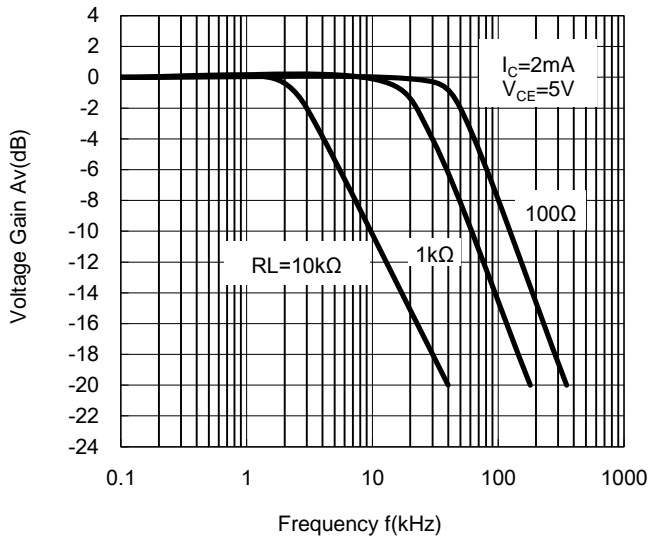


Fig.10 Response Time vs. Load Resistance



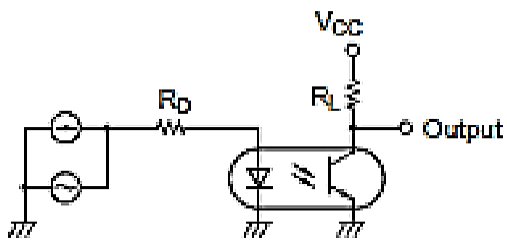
Fig.11 Frequency Response



TEST CIRCUIT RESPONSE TIME



TEST CIRCUIT FOR FREQUENCY RESPONSE



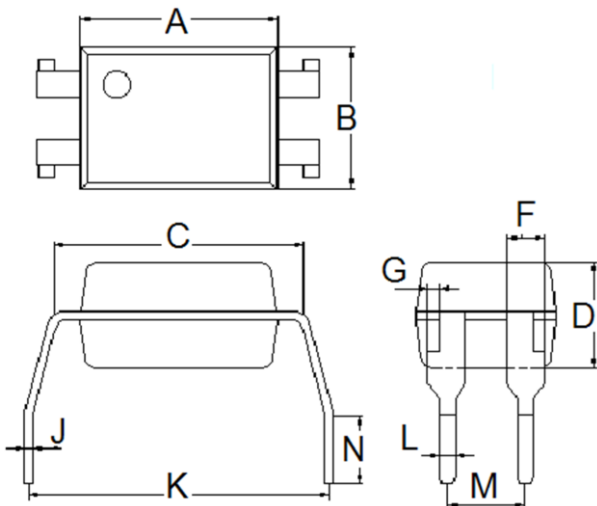
PACKAGE OUTLINE DIMENSION

DIP-4



| DIM. | Unit(mm) | |
|------|-----------|------|
| | Min | Max |
| A | 6.40 | 6.60 |
| B | 4.50 | 4.70 |
| C | 7.90 | 8.30 |
| D | 3.28 | 3.68 |
| E | 2° | 8° |
| F | 1.25 typ. | |
| H | 2.70 | 2.90 |
| J | 0.23 | 0.26 |
| K | 8.86 | 9.31 |
| L | 0.50 typ. | |
| M | 2.44 | 2.64 |
| N | 0.40 typ. | |

DIP-4M (Leads with 0.4" spacing)



| DIM. | Unit(mm) | |
|------|-----------|-------|
| | Min | Max |
| A | 6.40 | 6.60 |
| B | 4.50 | 4.70 |
| C | 7.90 | 8.30 |
| D | 3.28 | 3.68 |
| F | 1.25 typ. | |
| G | 0.40 typ. | |
| J | 0.23 | 0.26 |
| K | 9.86 | 10.46 |
| L | 0.50 typ. | |
| M | 2.44 | 2.64 |
| N | 2.40 | 2.90 |

PACKAGE OUTLINE DIMENSION



| DIM. | Unit(mm) | |
|------|-----------|-------|
| | Min | Max |
| A | 6.40 | 6.60 |
| B | 4.50 | 4.70 |
| C | 7.90 | 8.30 |
| D | 3.28 | 3.68 |
| F | 1.25 typ. | |
| G | 0.40 typ. | |
| H | 0.00 | 0.20 |
| J | 0.90 | 1.20 |
| K | 9.80 | 10.30 |
| L | 1.25 typ. | |
| M | 2.49 | 2.69 |

MARKING



Notes :

- 817: Product type
- B: CTR rank mark
- YWW: Date code

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Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9